09-26-2001 EET U.S. DEPARTMENT OF COMMERCE Patent and Trademark Office REC PTO-1595 101856307 To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof. Name and address of receiving party(ies): 1 Name of conveying party(ies): Taiwan Semiconductor Manufacturing Co. Ltd. No. 121 Park Avenue 3 Ming-Tsong Wang Science-Based Industrial Park Shi-Wei Wang Hsin-Chu, Taiwan, R.O.C. Shin-Kai Chen Additional name(s) & address(es) attached □ Yes Nature of conveyance: Assignment □ Merger □ Security Agreement □ Change of Name Other: Execution Date: July 18, 2001 4 Application number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application is: 07-18-01 B. Patent No(s) A. Patent Application No(s). 19/954858 Additional numbers attached? □ Yes ⊠ No Total number of applications and patents involved: 5 Name and address of party to whom correspondence concerning document should be mailed: \$40.00 Total fee (37 CFR 3.41) RANDY W. TUNG **Tung & Associates** 838 W. Long Lake Road **Enclosed** Suite 120 Authorized to charge credit card (w/filing fee) Bloomfield Hills, Michigan 48302 50-0484 Deposit Account Number: (Attach duplicate copy of this page if paying by deposit account) DO NOT USE THIS SPACE 1001 VTRLONGI (0000008 **04954858** 40.00 OF To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of Statement and signature.

the original document.

Randy W. Tung Name of Person Signing Registration No. 31,311

Signature

Total number of pages including cover sheet, attachments, and document : 3

Mail documents to be recorded with required cover sheet information to: Commissioner of Patents & Trademarks, Box Assignments Washington, D.C. 20231

ASSIGNMENT

WHEREAS, we, MING-TSONG WANG, SHI-WEI WANG and SHIN-KAI CHEN

have invented certain improvements in

COMPOSITE MICROELECTRONIC DIELECTRIC LAYER

WITH INHIBITED CRACK SUSCEPTIBILITY

for which we are about to make application for Letters Patent of the United States; and

WHEREAS, TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD. of

No. 121, Park Avenue 3, Science-Based Industrial Park, Hsin-Chu, Taiwan, R.O.C, is desirous of

acquiring the entire right, title and interest in and to said invention;

NOW, THEREFORE, in consideration of One Dollar (\$1.00) and other good and

valuable consideration, the receipt of which is hereby acknowledged, we, MING-TSONG WANG.

SHI-WEI WANG and SHIN-KAI CHEN, by these presents, do hereby sell, assign and transfer unto

the said corporation and its assigns, for the territory of the United States of America and all foreign

countries, the entire right, title and interest, including all priority rights under the International

Convention associated with each country of the Union, in and to said invention as described in the

patent application executed by us on the 18th day of 904, preparatory to

obtaining Letters Patent of the United States thereon, and in and to said application and any Letters

Patent that may be granted in pursuance of said application and any divisional, continuation or

1

PATENT REEL: 012184 FRAME: 0543 continuation-in-part application thereof, and in and to any reissue of any such patent, and in and to any patent applications which may be filed on said invention in countries foreign to the United States

and any Letters Patent granted thereon.

We further authorize said corporation to apply for foreign patents on said invention in its own name or through its designees, including subsidiaries, related companies or assignees, under the International Convention or otherwise, and we further agree to execute all papers, including those required for the United States and foreign applications, and to perform such other

proper acts as said corporation or its designees the rights herein assigned.

Ming. Joong Wang

SHI-WEI WANG

SHI-WEI WANG

SHIN-KAI CHEN SHIN-KAI CHEN

TUNG & ASSOCIATES 838 W. Long Lake Road Suite 120 Bloomfield Hills, Michigan 48302

RECORDED: 09/17/2001

2